

Docket No.: 050103-0553



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 20277
Rajiv Yadav RANJAN, et al. : Confirmation Number: 2760
Application No.: 10/776,203 : Group Art Unit: 1795
Filed: February 12, 2004 : Examiner: McDonald, Rodney Glenn
For: METHOD & APPARATUS FOR MULTI-STAGE SPUTTER DESPOSITION OF UNIFORM THICKNESS
LAYERS
Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith is an Amendment in the above-identified application.

- ☒ No additional fee is required.
☐ Applicant is entitled to small entity status under 37 CFR 1.27
☐ Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	24	24	0	\$50.00 =	\$0.00
Independent Claims	3	3	0	\$210.00 =	\$0.00
Multiple dependent claims newly presented					\$0.00
Fee for extension of time					\$0.00
					\$0.00
Total of Above Calculations					\$0.00

- ☐ Please charge my Deposit Account No. 500417 in the amount of \$0.00. An additional copy of this transmittal sheet is submitted herewith.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 500417, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,

McDERMOTT WILL & EMERY LLP

Bernard P. Codd

Registration No. 46,429

Please recognize our Customer No. 20277 as our
correspondence address.

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Date: April 14, 2008
WDC99 1554498-1.050103.0553



Docket No.: 050103-0553

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	:	Customer Number: 49745
Rajiv Yadav RANJAN, et al.	:	Confirmation Number: 2760
Application No.: 10/776,203	:	Group Art Unit: 1795
Filed: February 12, 2004	:	Examiner: McDonald, Rodney
For: METHOD & APPARATUS FOR MULTI-STAGE SPUTTER DEPOSITION OF UNIFORM THICKNESS LAYERS		

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The following Remarks and Amendment are submitted in response to the Office Action dated January 14, 2008.

Amendments to the claims begin on page 2 of this paper.

Remarks begin on page 9 of this paper.